

UNISONIC TECHNOLOGIES CO., LTD

9N70-TC2

Preliminary

9A, 700V **N-CHANNEL POWER MOSFET**

DESCRIPTION

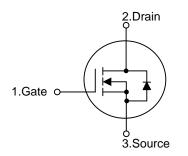
The UTC 9N70-TC2 is an N-channel mode power MOSFET using UTC's advanced technology to provide costumers with planar stripe and DMOS technology. This technology is specialized in allowing a minimum on-state resistance and superior switching performance. It also can withstand high energy pulse in the avalanche and commutation mode.

The UTC 9N70-TC2 is universally applied in active power factor correction and high efficient switched mode power supplies.

FEATURES

- * $R_{DS(ON)} \le 1.4 \Omega @ V_{GS} = 10V, I_D = 4.5A$
- * High switching speed
- * Improved dv/dt capability

SYMBOL

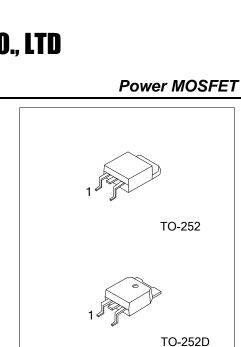


ORDERING INFORMATION

Ordering Number		Deekere	Pin Assignment			Desking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
9N70L-TN3-R	9N70G-TN3-R	TO-252	G	D	S	Tape Reel	
9N70L-TND-R	9N70G-TND-R	TO-252D	G	D	S	Tape Reel	

Note: Pin Assignment: G: Gate D: Drain S: Source

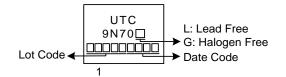
9N70G-TN3-R (1)Packing Type (2)Package Type (3)Green Package	 (1) R: Tape Reel (2) TN3: TO-252, TND: TO-252D (3) G: Halogen Free and Lead Free, L: Lead Free
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9N70-TC2

MARKING





■ ABSOLUTE MAXIMUM RATINGS (T_C=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain to Source Voltage		V _{DSS}	700	V	
Gate to Source Voltage		V _{GSS}	±30	V	
Continuous Drain Current	Continuous	I _D	9	А	
	Pulsed (Note 2)	I _{DM}	18	А	
Avalanche Energy	Single Pulsed (Note 3)	E _{AS}	126.2	mJ	
Peak Diode Recovery dv/c	It (Note 3)	dv/dt	3.88	V/ns	
Power Dissipation		PD	55	W	
Junction Temperature		ΤJ	+150	°C	
Storage Temperature		T _{STG}	-55 ~ +150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating : Pulse width limited by maximum junction temperature.

3. L = 30mH, I_{AS} = 2.9A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25°C

4. $I_{SD} \leq 9.0A$, di/dt $\leq 200A/\mu s$, $V_{DD} \leq BV_{DSS}$, Starting $T_J=25^{\circ}C$.

THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT
Junction to Ambient	θ_{JA}	110	°C/W
Junction to Case	θ」	2.27 (Note)	°C/W

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.



■ ELECTRICAL CHARACTERISTICS (T_J =25°C, unless otherwise specified)

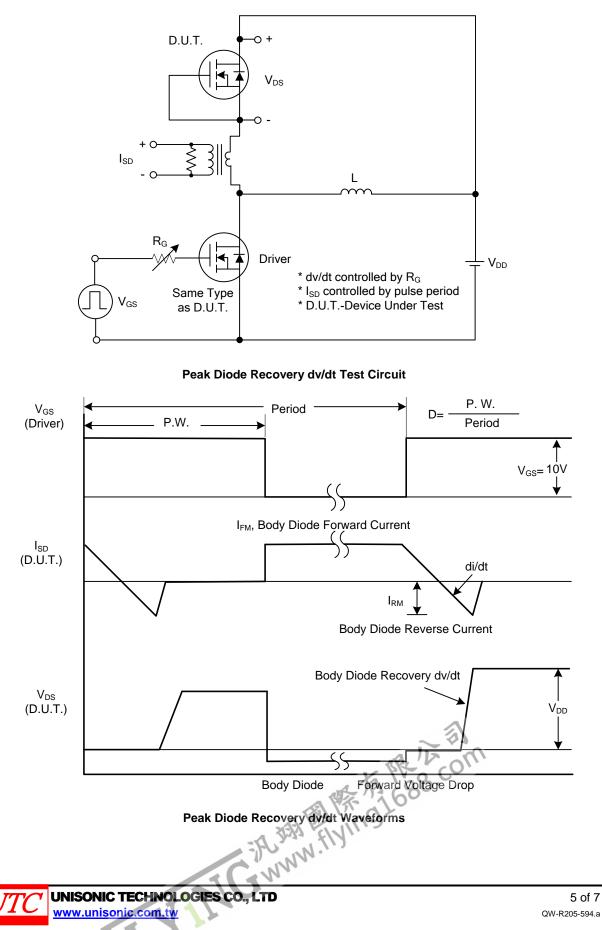
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	
OFF CHARACTERISTICS	OTWEOL		IVIIIN		1017 171	51111
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250µA	700			V
Drain-Source Leakage Current	I _{DSS}	V _{DS} =700V, V _{GS} =0V			10	μA
Forwar	d	V _{GS} =+30V, V _{DS} =0V			+100	nA
Gate- Source Leakage Current Revers	e I _{GSS}	V _{GS} =-30V, V _{DS} =0V			-100	nA
ON CHARACTERISTICS		•				
Gate Threshold Voltage	V _{GS(TH)}	V _{DS} =V _{GS} , I _D =250µA	2.0		4.0	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =4.5A			1.4	Ω
DYNAMIC CHARACTERISTICS						
Input Capacitance	CISS			1152		рF
Output Capacitance	C _{OSS}	V _{DS} =25V, V _{GS} =0V, f=1MHz		100		рF
Reverse Transfer Capacitance	C _{RSS}			4.4		рF
DYNAMIC CHARACTERISTICS						
Total Gate Charge	Q_{G}	V _{DS} =560V, V _{GS} =10V, I _D =9A I _G =1mA (Note 1, 2)		25		nC
Gate-Source Charge	Q_{GS}			6.5		nC
Gate-Drain Charge	Q_{GD}			4		nC
Turn-on Delay Time (Note 1)	t _{D(ON)}	V _{DS} =100V, V _{GS} =10V, I _D =9A, R _G =25Ω (Note 1, 2)		13.5		ns
Rise Time	t _R			18		ns
Turn-off Delay Time	t _{D(OFF)}			72		ns
Fall-Time	t _F			38		ns
SOURCE- DRAIN DIODE RATINGS AND (CHARACTERIS	TICS				
Maximum Continuous Drain-Source Diode	ls				9	А
Forward Current	IS				9	A
Maximum Pulsed Drain-Source Diode	Ism				18	А
Forward Current	ISM				10	~
Drain-Source Diode Forward Voltage (Note	1) V _{SD}	I _S =9A, V _{GS} =0V			1.4	V
Body Diode Reverse Recovery Time (Note	1) t _{rr}	I _S =9A, V _{GS} =0V,		474		nS
	`	dl _F /dt=100A/µs		+ +		
Body Diode Reverse Recovery Charge	Qrr			10		μC

Notes: 1. Pulse Test : Pulse width \leq 300µs, Duty cycle \leq 2%.

2. Essentially independent of operating temperature.

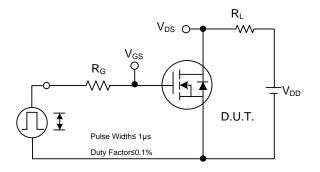
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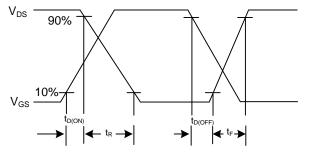
TEST CIRCUITS AND WAVEFORMS



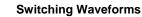
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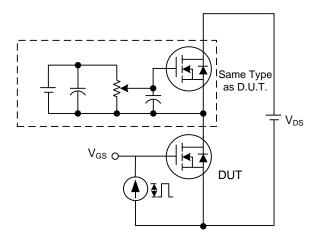
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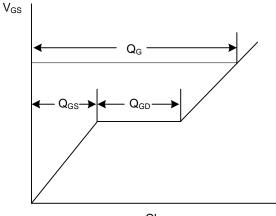


Switching Test Circuit



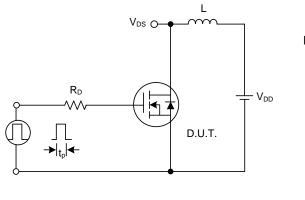


Gate Charge Test Circuit

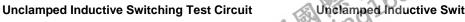


Charge

Gate Charge Waveform



t Unclamped Inductive Switching Waveforms





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